

DATASHEET

General Description

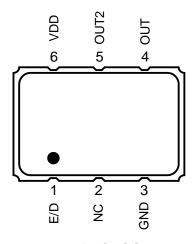
The XLP is an LVPECL Crystal Oscillator with 860fs typical phase jitter over 12kHz to 20 MHz bandwidth. Available in a wide frequency range from 0.750MHz to 1350MHz, the IDT XLP Series Crystal Oscillator utilizes a family of proprietary ASICs, with a key focus on noise reduction technologies.

The 3rd order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional Bulk Quartz and SAW oscillators. With short lead-time, low cost, low noise, wide frequency range, excellent ambient performance, the XLP is an excellent choice over the conventional technologies. The XLP has stabilities as tight as ±20ppm with extremely quick delivery for both standard and custom frequencies

Features

- Frequency range: 0.750 to 1350 MHz
- Output Type: LVPECL
- Frequency Stability: ± 20ppm, ± 25ppm, ± 50ppm, or ± 100 ppm
- Supply Voltage: 2.5V or 3.3V
- Phase Jitter (1.875MHz to 20MHz): 225fs typical
- Phase Jitter (12kHz to 20MHz): 860fs typical
- Package options: 5.0mm x 3.2mm x 1.2mm (JS6)
 7.0mm x 5.0mm x 1.3mm (JU6)
- Operating Temperatures: -20°C to +70°C or -40°C to +85°C

Pin Assignment



6-pin CLCC

Pin Descriptions

Pin Number Pin Name		Description
1	E/D	Enable/Disable ¹ (0=Output Disabled)
2	NC	No connect
3	GND	Connect to ground
4	OUT	Output
5	OUT2	Complementary Output
6	VDD	Supply voltage

^{1.} Pulled high internally.



Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the XLP. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
VDD	-0.5 to +5.0 V
E/D	-0.5 V to VDD + 0.5 V
OUT	-0.5 V to VDD + 0.5 V
Storage Temperature	-55°C to 125°C
Theta Ja (Junction to Ambient)	102°C/W – Still Air

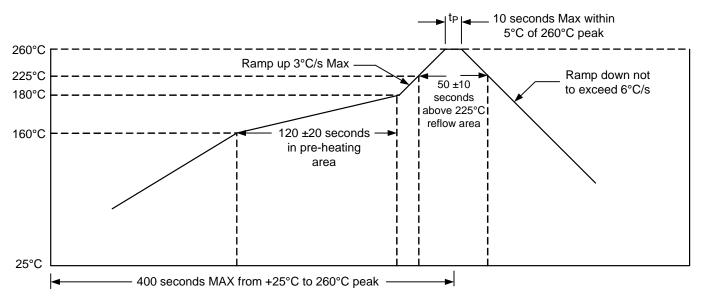
ESD Compliance

Human Body Model (HBM	1000V
Machine Model (MM)	150V

Mechanical Testing

Parameter	Test Method
Mechanical Shock	Drop from 75cm to hardwood surface–3 times
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 minute sweep 2 hours each in 3 directions (X, Y, Z)
High Temperature Burn-in	Under power @ 125°C for 2000 hours
Hermetic Seal	He pressure: 4 ±1kgf/cm ² 2 hour soak

Solder Reflow Profile





DC Characteristics

 $(V_{DD}= 3.3 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply Current	I _{DD}	Common Frequencies			120	mA
Output HIGH Voltage	V _{OH}	Standard LVPECL load	2.055		2.405	V
Output LOW Voltage	V _{OL}	Standard LVPECL load	1.305		1.650	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V _{IH}		70%V _{DD}			V
Enable/Disable Input LOW Voltage (Output disabled)	V _{IL}				30%V _{DD}	V

^{*} A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

 $(V_{DD}= 3.3 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Output Frequency Range	F _{OUTR}		0.750		1350	MHz
Frequency Stability		Temperature = -20°C to +70°C	±20		±100	ppm
		Temperature = -40°C to +85°C	±25		±100	ppm
Aging (1 st year)		Ta = 25°C			3	
Aging (10 years)		Ta = 25°C			10	
Output Load		To VDD - 2.0V		50		Ohms
Start-up Time	T _{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V _{PP}			400	ps
Output Fall Time		80% to 20% V _{PP}			400	ps
Output Clock Duty Cycle	T _{DTCY}	50%VP-P	45		55	%
Output Enable/ Disable Time	T _{OE}				100	ns
Period Jitter, RMS	J _{PER}	Frequency = 156.25MHz		5.80		ps
Random Jitter	R _J	Frequency = 156.25MHz		1.29		ps
Deterministic Jitter	DJ	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		9.3		ps
Total Jitter	T _J	omor and digital quality opcomouncing,		27.7		ps
Phase Jitter (12kHz – 20MHz)	Ф _{ЛІТТЕК}	Common Frequencies		860		fs
Phase Noise Performance	φ _{NOISE}	100Hz of Carrier		-80		dBc/Hz
Frequency = 156.25MHz	ИНz	1kHz of Carrier		-115		dBc/Hz
		10kHz of Carrier		-117		dBc/Hz
		100kHz of Carrier		-121		dBc/Hz
		1MHz of Carrier		-142		dBc/Hz
		10MHz of Carrier		-150		dBc/Hz
Output Frequency (Common)	F _{OUT}	100MHz, 106.25MHz, 1258MHz, 150MH 212.5MHz, 250MHz, 300MHz, 312.5MH (Contact IDT for additional frequencies)		IHz, 156.25	MHz, 200M	Hz,

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices



DC Characteristics

 $(V_{DD}= 2.5 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

Parameter	Symbol	Condition	Min	Тур	Max	Units
Power Supply Current	I _{DD}	Common Frequencies	33		72	mA
Output HIGH Voltage	V _{OH}	Standard LVPECL load		1.40		V
Output LOW Voltage	V _{OL}	Standard LVPECL load		0.68		V
Enable/Disable Input HIGH Voltage (Output enabled)*	V _{IH}		70%V _{DD}			V
Enable/Disable Input LOW Voltage (Output disabled)	V _{IL}				30%V _{DD}	V

^{*} A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

 $(V_{DD}= 2.5 V \pm 5\%, T_A= -20^{\circ}C \text{ to } +70^{\circ}C; -40^{\circ} \text{ to } +85^{\circ}C)$

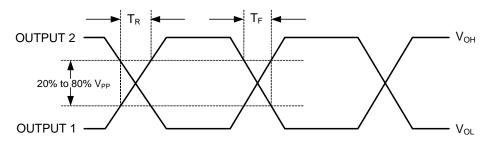
Parameter	Symbol	Condition	Min	Тур	Max	Units
Output Frequency Range	F _{OUTR}		0.750		1000	MHz
Frequency Stability		Temperature = -20°C to +70°C	±20		±100	ppm
		Temperature = -40°C to +85°C	±25		±100	ppm
Output Load		To Vdd - 2.0V		50		Ohms
Start-up Time	T _{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V _{PP}			400	ps
Output Fall Time		80% to 20% V _{PP}			400	ps
Output Clock Duty Cycle	T _{DTCY}	50%VP-P	45		55	%
Output Enable/ Disable Time	T _{OE}				100	ns
Period Jitter, RMS	J _{PER}	Frequency = 156.25MHz		5.12		ps
Random Jitter	R _J	Frequency = 156.25MHz		1.36		ps
Deterministic Jitter	DJ	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		10.0		ps
Total Jitter	T _J	onior and orginal adding oppositionions,		29.3		ps
Phase Jitter (12kHz – 20MHz)	Ф _{JITTER}	Frequency = 156.25MHz		1200		fs
Phase Noise Performance	ф _{NOISE}	100Hz of Carrier		-83.2		dBc/Hz
Frequency = 156.25MHz		1kHz of Carrier		-106.5		dBc/Hz
		10kHz of Carrier		-115.6		dBc/Hz
		100kHz of Carrier		-120.2		dBc/Hz
		1MHz of Carrier		-136.1		dBc/Hz
		10MHz of Carrier		-145.9		dBc/Hz
Output Frequency (Standards)	F _{OUT}	100MHz, 106.25MHz, 1258MHz, 150MH 212.5MHz, 250MHz, 300MHz, 312.5MH (Contact IDT for additional frequencies)			MHz, 200M	Hz,

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices

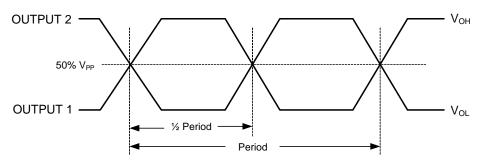


Output Waveform

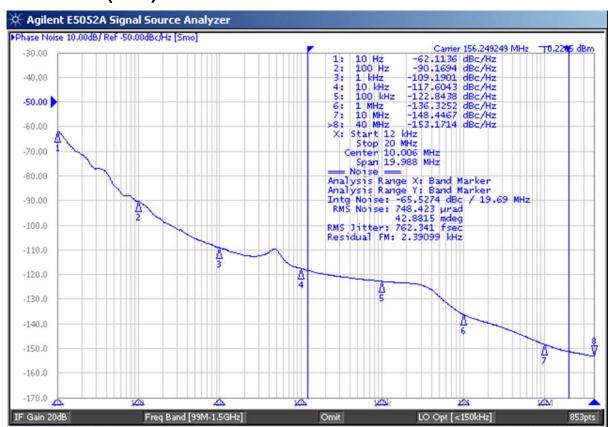
Rise Time/Fall Time Measurements



Oscillator Symmetry



Typical Phase Noise (3.3V)

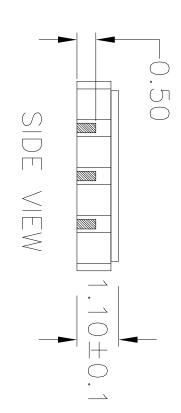


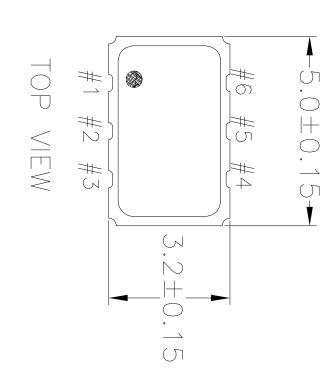


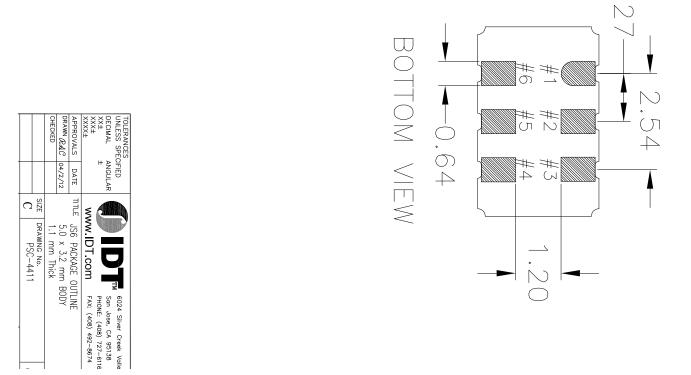
JS6 Package Outline and Dimensions

NOTES:

1. ALL DIMENSIONS IN MM.







	0 /0 /1		202
ΚS	12/03/12	UPDATED LID TOLERANCES	02
ΚS	07/12/12	ADDED LID IN TOP VIEW	01
DP	04/2/12	INITIAL RELEASE	00
APPRO	DATE	DESCRIPTION	REV



JS6 Package Outline and Dimensions (cont.)

- 7351B

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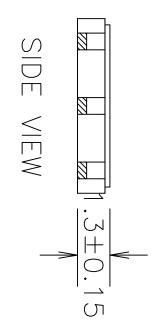
	REVISIONS		
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	04/2/12	DP
01	ADDED LID IN TOP VIEW	07/12/12	KS
02	UPDATED LID TOLERANCES	12/03/12	KS
7	HEDATE PACKAGE DRAWING	8/8/14	

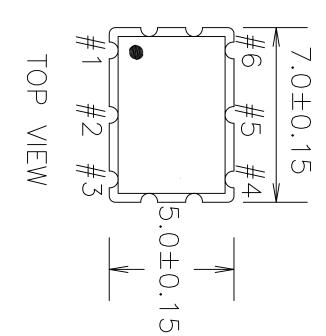
DO NOT SCALE DRAWING

SHEET 2 OF 2



JU6 Package Outline and Dimensions





<u>#2</u>]

BOTTOM VIEW #6 5.08

		CHECKED	DRAWN XL	APPROVALS	TOLERANCES UNLESS SPECIFIED DECIMAL ANGU XX4 ± XXXX+ XXXXX4
			10/03/12	DATE	CIFIED ANGULAR
7 PSC-4430		1.3 mm Thick	7.0 x 5.0 mm BODY	TITLE JU6 PACKAGE OUTLINE	TOLERANCES TOLERANCES UNILESS SPECIFIED UNILESS SPECIFIED Som Joses, CA. 95138 SNX4 ± WWWW.IDT.COM FAX: (408) 727-6116 XXX4 XXXX± WWWW.IDT.COM FAX: (408) 492-8674
3	RΕV				2 2

NOTES:

1. ALL DIMENSIONS IN MM.

오찍



DO NOT SCALE DRAWING

SHEET 2 OF 2

JU6 Package Outline and Dimensions (cont.)

RECOMMENDED LAND PATTERN

- ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
 TOP DOWN VIEW. AS VIEWED ON PCB.
 COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
 LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
 LAND PATTERN RECOMMENDATION PER IPC—7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN

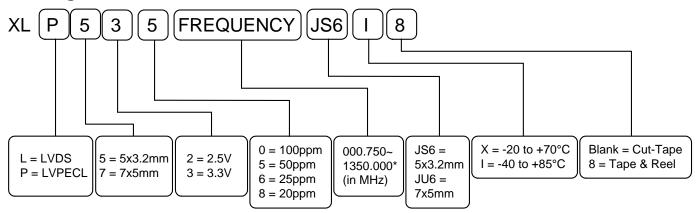
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	CHECKED	APPROVALS	IOLEKANCES UNLESS SPECIFIED DECIMAL ANGULAR XX± ± XXXX± XXXX± XXXXX±
	10/03/12		CIFIED ANGULAR
C	1.3	שחבב שווו	ww.
DRAWING No. PSC-4430	mm Thick	PACKAGE	www.IDT.com
	BOUT	OUTLINE	TM San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674
20			Creek Valley R DA 95138 B) 727-6116 492-8674

AUH.L	8/12/14	1 UPDATE PACKAGE DRWING	3
ĸ	10/5/12	0 INITIAL RELEASE	8
APPROVED	DATE	EV DESCRIPTION	REV
		REVISIONS	



Ordering Information



^{*} See table or contact IDT for custom frequencies

Revision History

Rev.	Date	Originator	Description of Change
Α	10/17/14	B. Chandhoke	Initial release.
В	12/10/14	B. Chandhoke	 Added 7 x 5 x 1.3mm JU6 package option and package dimension/landing pattern drawings. Updated ordering information table/graphic to show JU6 package option.



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